MUN2132, MMUN2132L, MUN5132, DTA143EE, DTA143EM3, NSBA143EF3

Digital Transistors (BRT) R1 = 4.7 k Ω , R2 = 4.7 k Ω

PNP Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_A = 25° C)

Rating	Symbol	Max	Unit
Collector-Base Voltage	V _{CBO}	50	Vdc
Collector–Emitter Voltage	V _{CEO}	50	Vdc
Collector Current – Continuous	Ι _C	100	mAdc
Input Forward Voltage	V _{IN(fwd)}	30	Vdc
Input Reverse Voltage	V _{IN(rev)}	10	Vdc

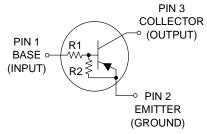
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

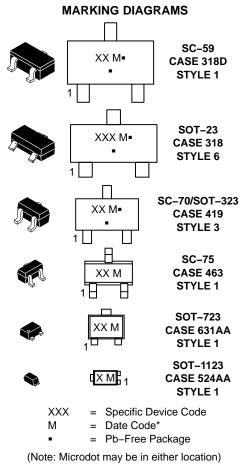


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*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking, and shipping information in the package dimensions section on page 2 of this data sheet.

MUN2132, MMUN2132L, MUN5132, DTA143EE, DTA143EM3, NSBA143EF3

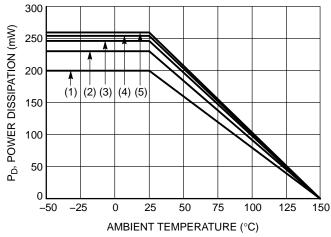
Table 1. ORDERING INFORMATION

Device	Part Marking	Package	Shipping [†]
MUN2132T1G, NSVMUN2132T1G*	6J	SC–59 (Pb–Free)	3000 / Tape & Reel
MMUN2132LT1G, NSVMMUN2132LT1G*	A6J	SOT-23 (Pb-Free)	3000 / Tape & Reel
MUN5132T1G, NSVMUN5132T1G*	6J	SC-70/SOT-323 (Pb-Free)	3000 / Tape & Reel
DTA143EET1G	43	SC-75 (Pb-Free)	3000 / Tape & Reel
DTA143EM3T5G, NSVDTA143EM3T5G*	6J	SOT-723 (Pb-Free)	8000 / Tape & Reel
NSBA143EF3T5G	A (90°)*	SOT–1123 (Pb–Free)	8000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

** $(xx^{\circ}) = Degree rotation in the clockwise direction.$



(1) SC-75 and SC-70/SOT-323; Minimum Pad
(2) SC-59; Minimum Pad
(3) SOT-23; Minimum Pad
(4) SOT-1123; 100 mm², 1 oz. copper trace
(5) SOT-723; Minimum Pad

Figure 1. Derating Curve

Table 2. THERMAL CHARACTERISTICS

	Characteristic	Symbol	Max	Unit
THERMAL CHARACTERISTIC	CS (SC–59) (MUN2132)			
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1)		PD	230	mW
(Note 2) Derate above 25°C (Note 2)	(Note 1)		338 1.8 2.7	mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	R _{θJA}	540 370	°C/W
Thermal Resistance, Junction to Lead (Note 2)	(Note 1)	R _{θJL}	264 287	°C/W
Junction and Storage Tempera	ature Range	T _J , T _{stg}	-55 to +150	°C
THERMAL CHARACTERISTIC	CS (SOT-23) (MMUN2132L)			
$\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C & (Note 1) \\ (Note 2) \\ \mbox{Derate above } 25^\circ C \\ (Note 2) \end{array}$	(Note 1)	PD	246 400 2.0 3.2	mW mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{ hetaJA}$	508 311	°C/W
Thermal Resistance, Junction to Lead (Note 2)	(Note 1)	R _{θJL}	174 208	°C/W
Junction and Storage Tempera	ature Range	T _J , T _{stg}	-55 to +150	°C
THERMAL CHARACTERISTIC	CS (SC-70/SOT-323) (MUN5132)			
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) (Note 2)		P _D	202 310	mW
Derate above 25°C (Note 2)	(Note 1)		1.6 2.5	mW/°C
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{ heta JA}$	618 403	°C/W
Thermal Resistance, Junction to Lead (Note 2)	(Note 1)	$R_{ heta JL}$	280 332	°C/W
Junction and Storage Tempera	ature Range	T _J , T _{stg}	–55 to +150	°C
THERMAL CHARACTERISTIC	CS (SC-75) (DTA143EE)			
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) (Note 2) Derate above 25^{\circ}C	(Note 1)	P _D	200 300 1.6	mW mW/°C
(Note 2) Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	R _{θJA}	2.4 600 400	°C/W
Junction and Storage Tempera		T _J , T _{stg}	-55 to +150	°C
THERMAL CHARACTERISTIC	5	0, SiQ	I	
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) (Note 2) Derate above 25^{\circ}C	(Note 1)	PD	260 600 2.0	mW mW/°C
(Note 2) Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	R _{θJA}	4.8 480 205	°C/W

2. FR-4 @ 1.0 x 1.0 Inch Pad.

FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.

Table 2. THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
THERMAL CHARACTERISTICS (SOT-1123) (NSBA143EF3)			
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 3) (Note 4) Derate above 25^{\circ}C (Note 3) (Note 4)	P _D	254 297 2.0 2.4	mW mW/°C
Thermal Resistance,(Note 3)Junction to Ambient(Note 4)	$R_{ hetaJA}$	493 421	°C/W
Thermal Resistance, Junction to Lead (Note 3)	R _{θJL}	193	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

1. FR-4 @ Minimum Pad.

FR-4 @ 1.0 x 1.0 Inch Pad.
 FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.

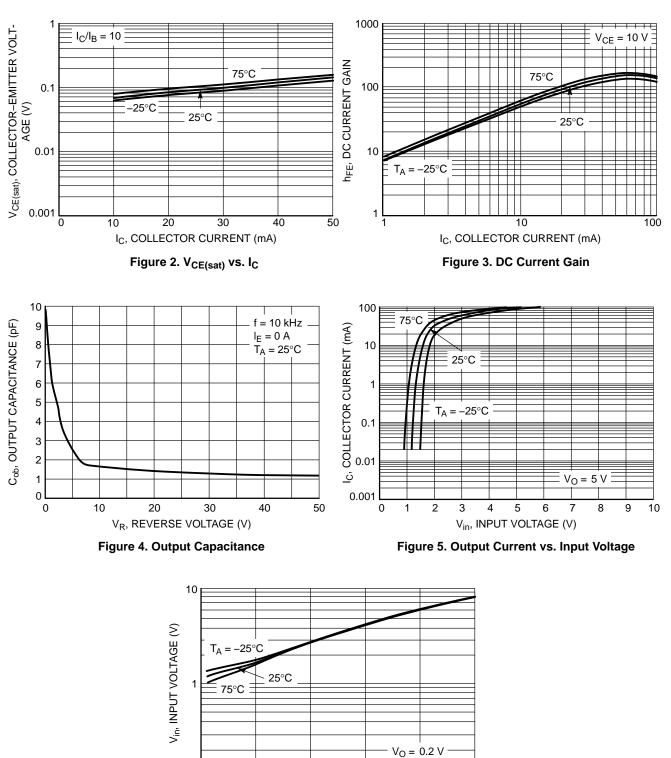
Table 3. ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector–Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I _{CBO}	_	_	100	nAdc
Collector–Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$	I _{CEO}	_	_	500	nAdc
Emitter–Base Cutoff Current ($V_{EB} = 6.0 \text{ V}, I_C = 0$)	I _{EBO}	_	-	1.5	mAdc
Collector–Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$	V _{(BR)CBO}	50	_	-	Vdc
Collector–Emitter Breakdown Voltage (Note 5) $(I_{C} = 2.0 \text{ mA}, I_{B} = 0)$	V _(BR) CEO	50	_	-	Vdc
ON CHARACTERISTICS			-		
DC Current Gain (Note 5) ($I_C = 5.0 \text{ mA}, V_{CE} = 10 \text{ V}$)	h _{FE}	15	27	_	
Collector–Emitter Saturation Voltage (Note 5) $(I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA})$	V _{CE(sat)}	_	_	0.25	Vdc
Input Voltage (off) (V _{CE} = 5.0 V, I _C = 100 μA)	V _{i(off)}	_	1.2	0.5	Vdc
Input Voltage (on) ($V_{CE} = 0.3 \text{ V}, I_C = 20 \text{ mA}$)	V _{i(on)}	3.0	2.4	-	Vdc
Output Voltage (on) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 2.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V _{OL}	_	_	0.2	Vdc
Output Voltage (off) (V _{CC} = 5.0 V, V _B = 0.25 V, R _L = 1.0 k Ω)	V _{OH}	4.9	_	_	Vdc
Input Resistor	R1	3.3	4.7	6.1	kΩ
Resistor Ratio	R ₁ /R ₂	0.8	1.0	1.2	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle $\leq 2\%$.

MUN2132, MMUN2132L, MUN5132, DTA143EE, DTA143EM3, NSBA143EF3



TYPICAL CHARACTERISTICS MUN2132, MMUN2132L, MUN5132, DTA143EE, DTA143EM3

I_C, COLLECTOR CURRENT (mA) Figure 6. Input Voltage vs. Output Current

30

40

50

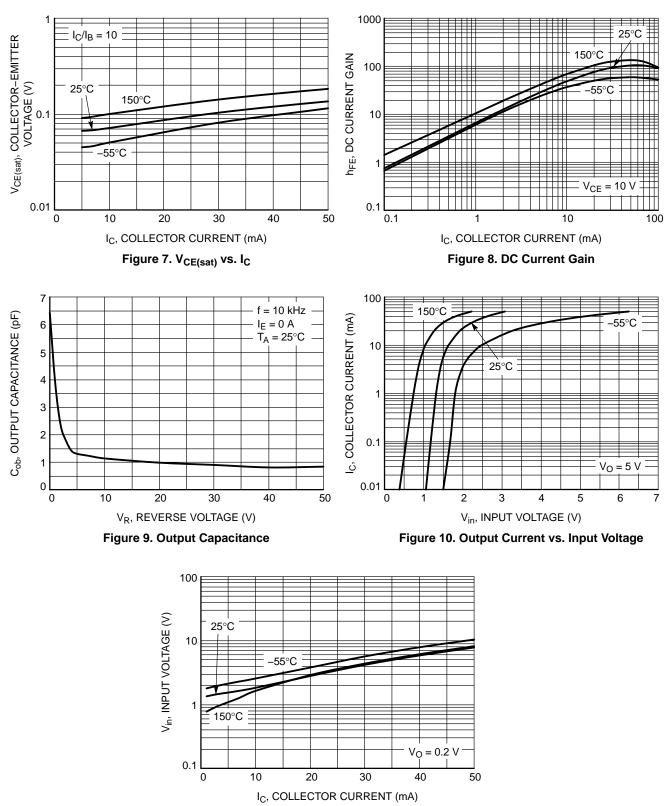
20

0.1

0

10

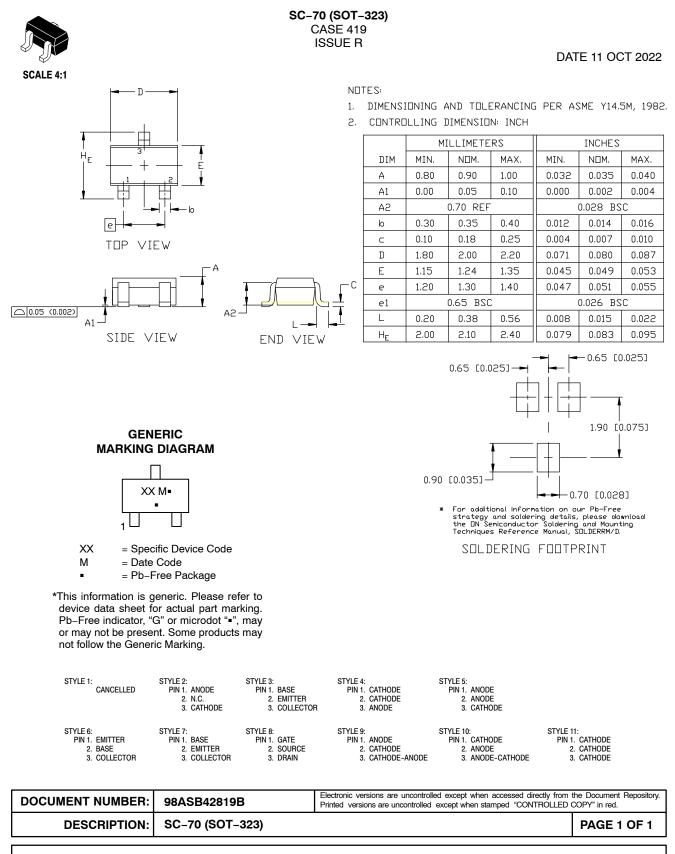
MUN2132, MMUN2132L, MUN5132, DTA143EE, DTA143EM3, NSBA143EF3



TYPICAL CHARACTERISTICS – NSBA143EF3

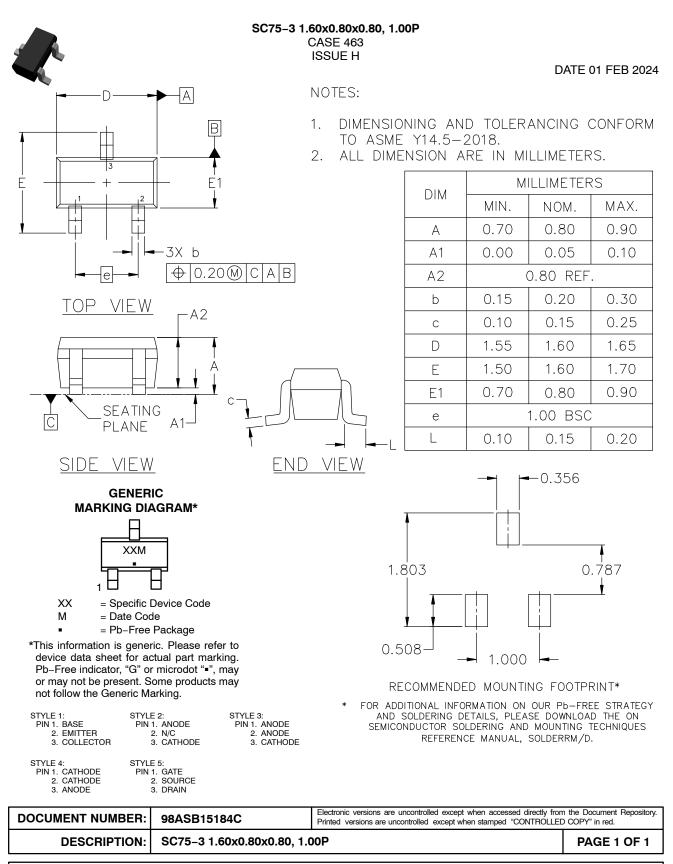
Figure 11. Input Voltage vs. Output Current

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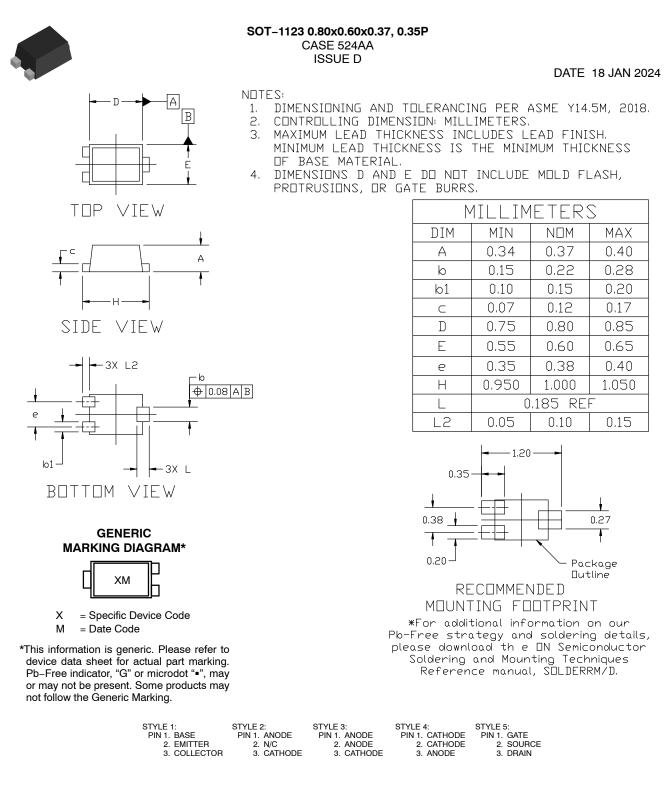
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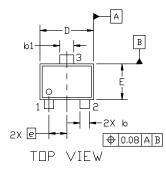


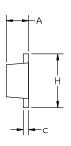
SOT-723 1.20x0.80x0.50, 0.40P CASE 631AA ISSUE E

DATE 24 JAN 2024

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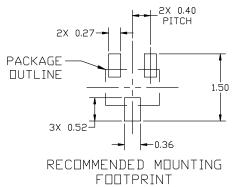
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSION: MILLIMETERS. 1.
- 2.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM З. LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS OR GATE BURRS.



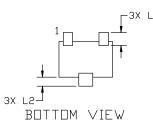


SIDE VIEW

		MILLIMETERS				
	DIM	MIN.	NDM.	MAX.		
1	А	0.45	0.50	0.55		
	b	0.15	0.21	0.27		
	b1	0.25	0.31	0.37		
	С	0.07	0.12	0.17		
	D	1.15	1.20	1.25		
	E	0.75	0.80	0.85		
	e	0.40 BSC				
	Н	1.15	1.20	1.25		
	L	0.29 REF				
	L2	0.15	0.20	0.25		



*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.



GENERIC **MARKING DIAGRAM***



XX = Specific Device Code Μ = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

PIN 1. BASE PIN 2. EMITTER		2. ANODE 2	4: . CATHODE . CATHODE . ANODE	STYLE 5: PIN 1. GATE 2. SOURCE 3. DRAIN		
DOCUMENT NUMBER: 98AON12989D					ept when accessed directly from t t when stamped "CONTROLLED C	
DESCRIPTION: SOT-723 1.20x0.80x0.50, 0.40P				PAGE 1 OF 1		

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